

Special Issue

Cohesive Subgraph Computation over Massive Sparse Networks

Message from the Guest Editors

Our concrete intention in this Special Issue is to bring together researchers, scholars, and contributors to share their ongoing and latest research with regards to existing theoretical, methodological contributions as well as the development of new methods/approaches in cohesive subgraph computation over large graphs. From this perspective, this Special Issue welcomes high-quality and unpublished papers that present significant advances in the development and application of graph model, graph computation, subgraph mining, community search/detection, graph clustering, subgraph matching, and graph analysis.

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Deadline for manuscript submissions

closed (20 September 2022)



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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